

08-31-2006

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attached original documents or copy thereof.

To the Honorable Commissioner of

103299920

address of receiving party(ies)

1. Name of conveying party(ies):

Ryuji YOSHINO and Osamu TAKENOUCHI

Name: YAMASHITA ELECTRIC CO. LTD.

Internal Address: No. 6-33 Minamishinagawa 3-chome Shinagawa-ku TOKYO, JAPAN

Additional name(s) of conveying party(ies) attached? Yes No

Street Address:

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other

City: State:

Execution Date: 28 JUNE 2006

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 6/27/06

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Martin Smolowitz, Esq.
Internal Address: 57 DRIFTWOOD DR. Suite 200 Port Washington NY 11050

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00

- Enclosed
- Authorized to be charged to deposit account

Street Address:

8. Deposit account number:

19-3223

City: State: ZIP:

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

MARTIN Smolowitz

Martin Smolowitz

8/25/06

Name of Person Signing

Signature

Date

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Total number of pages including cover sheet, attachments, and document: 2

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(40.00 fee)

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

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ASSIGNMENT
UNITED STATES OF AMERICA

Whereas, I/we (1) Ryuji YOSHINO of (2) c/o Yamashita Electric Co., Ltd. No. 6-33, Minamishinagawa 3-chome, Shinagawa-ku, Tokyo, JAPAN, and (3) Osamu TAKENOUCHI of (4) c/o Yamashita Electric Co., Ltd. No. 6-33, Minamishinagawa 3-chome, Shinagawa-ku, Tokyo, JAPAN have invented certain new and useful improvements in (5) SYNTHETIC RESIN MOLDING MOLD ASSEMBLY

for which applicable of Letters Patent in the United States of America

(6) is about to be made:

has been made

And Whereas, (7) Yamashita Electric Co., Ltd. of (8) No. 6-33, Minamishinagawa 3-chome, Shinagawa-ku, Tokyo, JAPAN is/are desirous of acquiring an interest therein and in the Letters Patent to be obtained therefor:

Now Therefore, be it known by all whom it may concern, that for good and valuable consideration (the sufficiency of which is hereby acknowledged) I/we have assigned, tranferred and set over, and by these presents do assign, tranfer and set over unto the said (7) Yamashita Electric Co., Ltd.

for the territory of the United States of America, and not elsewhere: the full and exclusive right, title and interest in and to the said invention, as fully set forth and described in the specification

prepared and executed by me/us on (9) June 27, 2006

filed in the U.S. Patent Office under Serial No. (10) _____

on (11) _____

preparatory to obtaining Letters Patent therefor: said invention, application and Letters Patent to be held and enjoyed by the said (7) _____

Yamashita Electric Co., Ltd.

to the full end of the term for which said Letters Patent are granted, as fully and entirely as the same would have been held by me/us had this assignment and transfer not been made.

In testimony whereof, I/we have hereunto set my/our hand this (12) 28th day of June 2006.

WITNESS:

(1) Ryuji YOSHINO

(3) Osamu TAKENOUCHI

Applicant or Patentee: Ryuji YOSHINO and Osamu TAKENOUCHI Attorney's
Serial or Patent No.: _____ Docket No.: MS/8910
Filed or Issued: _____
For: SYNTHETIC RESIN MOLDING MOLD ASSEMBLY

VERIFIED STATEMENT (DECLARATION) CLAIMING SMALL ENTITY
STATUS (37 CFR 1.9(f) and 1.27(b)) - INDEPENDENT INVENTOR

As a below named inventor, I hereby declare that I qualify as an independent inventor as defined in 37 CFR 1.9(c) for purposes of paying reduced fees under section 41(a) and (b) of Title 35, United States Code, to the Patent and Trademark Office with regard to the invention entitled SYNTHETIC RESIN MOLDING MOLD ASSEMBLY described in

- the specification filed herewith
 application serial no. _____, filed _____
 patent no. _____, issued _____

I have not assigned, granted, conveyed or licensed and am under no obligation under contract or law to assign, grant, convey or license, any rights in the invention to any person who could not be classified as an independent inventor under 37 CFR 1.9(c) if that person had made the invention, or to any concern which would not qualify as a small business concern under 37 CFR 1.9(d) or a nonprofit organization under 37 CFR 1.9(e).

Each person, concern or organization to which I have assigned, granted, conveyed, or licensed or am under an obligation under contract or law to assign, grant, convey, or license any rights in the invention is listed below:

- no such person, concern or organization
 persons, concerns or organizations listed below:

Full NAME Yamashita Electric Co., Ltd.
ADDRESS No. 6-33, Minamishinagawa 3-chome, Shinagawa-ku, Tokyo, JAPAN
 INDIVIDUAL SMALL BUSINESS CONCERN NONPROFIT ORGANIZATION

I acknowledge the duty to file, in this application or patent, notification of any change in status resulting in loss of entitlement to small entity status prior to paying, or at the time of paying, the earliest of the issue fee or any maintenance fee due after the date on which status as a small entity is no longer appropriate. (37 CFR 1.28(b))

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application, any patent issuing thereon, or any patent to which this verified statement is directed.

Ryuji YOSHINO
NAME OF INVENTOR
Ryuji YOSHINO
SIGNATURE OF INVENTOR

Osamu TAKENOUCHI
NAME OF INVENTOR
Osamu TAKENOUCHI
SIGNATURE OF INVENTOR

June 27, 2006
DATE

June 27, 2006
DATE

Applicant or Patentee: Ryuji YOSHINO and Osamu TAKENOUCHE Attorney's
Serial or Patent No.: _____ Docket No.: MS 8910
Filed or Issued: _____
For: SYNTHETIC RESIN MOLDING MOLD ASSEMBLY

VERIFIED STATEMENT (DECLARATION) CLAIMING SMALL ENTITY STATUS
(37 CFR 1.9(f) and 1.27(c)) - SMALL BUSINESS CONCERN

I hereby declare that I am

- the owner of the small business concern identified below:
- an official of the small business concern empowered to act on behalf of the concern identified below:

NAME OF CONCERN Yamashita Electric Co., Ltd.
ADDRESS OF CONCERN No. 6-33, Minamishinagawa 3-chome, Shinagawa-ku, Tokyo, JAPAN

I hereby declare that the above identified small business concern qualifies as a small business concern as defined in 13 CFR 121.3-18, and reproduced in 37 CFR 1.9(d), for purposes of paying reduced fees under section 41(a) and (b) of Title 35, United States Code, in that the number of employees of the concern, including those of its affiliates, does not exceed 500 persons. For purposes of this statement, (1) the number of employees of the business concern is the average over the previous fiscal year of the concern of the persons employed on a full-time, part-time or temporary basis during each of the pay periods of the fiscal year, and (2) concern are affiliates of each other when either, directly or indirectly, one concern controls or has the power to control the other, or a third party or parties controls or has the power to control both.

I hereby declare that rights under contract or law have been conveyed to and remain with the small business concern identified above with regard to the invention, entitled SYNTHETIC RESIN MOLDING MOLD ASSEMBLY by inventor(s) Ryuji YOSHINO and Osamu TAKENOUCHE described in

- the specification filed herewith
- application serial no. _____, filed _____
- patent no. _____, issued _____

If the rights held by the above identified small business concern are not exclusive, each individual, concern or organization having rights to the invention is listed below and no rights to the invention are held by any person, other than the inventor, who could not qualify as a small business concern under 37 CFR 1.9(d) or by any concern which would not qualify as a small business concern under 37 CFR 1.9(d) or a nonprofit organization under 37 CFR 1.9(e).

NAME _____
ADDRESS _____
 INDIVIDUAL SMALL BUSINESS CONCERN NONPROFIT ORGANIZATION

I acknowledge the duty to file, in this application or patent, notification of any change in status resulting in loss of entitlement to small entity status prior to paying, or at the time of paying, the earliest of the issue fee or any maintenance fee due after the date on which status as a small entity is no longer appropriate. (37 CFR 1.28(b))

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application, any patent issuing thereon, or any patent to which this verified statement is directed.

NAME OF PERSON SIGNING Katsuyoshi YAMASHITA
TITLE OF PERSON OTHER THAN OWNER President
ADDRESS OF PERSON SIGNING No. 6-33, Minamishinagawa 3-chome, Shinagawa-ku, Tokyo, JAPAN

SIGNATURE  DATE June 27, 2006